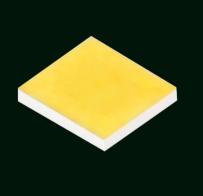




Bridgelux® CSP 1919 Series

Product Data Sheet DS954

CSP 1919



Introduction

The Bridgelux Chip Scale Package (CSP) 1919 LED offers exceptional performance in an ultra compact size. This CSP LED is hot-color targeted which ensures that the LEDs fall within their specified color bin at the typical application conditions of 85°C. With its superior performance without bonding wires and ability to assemble a densely populated and high luminous flux LED board, the CSP 1919 provides unparalleled design-in flexibility for indoor and outdoor lighting applications. The CSP 1919 is ideal as a drop in replacement for emitters with an industry standard 1.9mm x 1.9mm footprint.

Features

- · Competitive efficacy and lumen per dollar
- Industry-standard 1919 footprint, 1-sided emitter
- · Excellent color maintenance
- · Compatible with SMT
- Superior luminous flux at maximum current for reduced LED count
- Hot-color targeting ensures that color is within the ANSI bin at the typical application conditions of 85°C
- Enables 3- and 5-step MacAdam ellipse custom binning kits
- 120 degrees viewing angle
- Multiple CCT and CRI configurations for a wide range of lighting applications

Benefits

- · Lower operating and manufacturing cost
- · Ease of design and rapid go-to-market
- · Uniform consistent white light
- · Reliable and constant white point
- Environmentally friendly, complies with standards
- · Design flexibility

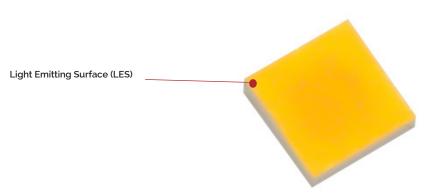
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Product Feature Map

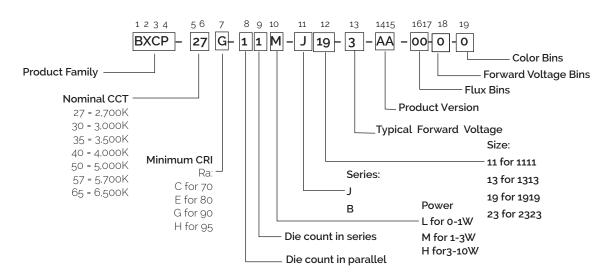
Bridgelux CSP LED products offer exceptional performance and color quality all in a highly reliable, cost effective, compact package. Our CSP products come in industry standard package sizes and follow ANSI binning standards.

These LEDs are optimized for cost and performance, helping to ensure highly competitive system lumen per dollar performance while addressing the stringent efficacy and reliability standards required for modern lighting applications.



Product Nomenclature

The part number designation for Bridgelux CSP 1919 is explained as follows:



Product Test Conditions

Bridgelux CSP 1919 LEDs are tested and binned with a 10ms pulse of 350mA at T_j (junction temperature)= T_{sp} (solder point temperature) =85°C. Luminous flux .color and forward voltage are binned at $T_i = T_{sp} = 85$ °C.

Product Selection Guide

The following product configurations are available:

Table 1: Selection Guide, Pulsed Measurement Data at 500mA ($T_i = T_{so} = 25^{\circ}C$)

Part Number ¹⁸	Nominal CCT ²	Nominal CCT ² CRI ^{3, 5}		Nominal Forward Voltage4.5 Drive Current (V)		Typical Pulsed Flux ^{4,5}	Typical Power	Typical Efficacy	
	(K)		(mA)	Min	Typical	Max	(lm)	(W)	(lm/W)
BXCP-30C-11M-J19-3-A1-00-0-0	3000	70	500	2.80	3.00	3.30	240	1.50	160
BXCP-40C-11M-J19-3-A1-00-0-0	4000	70	500	2.80	3.00	3.30	252	1.50	168
BXCP-50C-11M-J19-3-A1-00-0-0	5000	70	500	2.80	3.00	3.30	252	1.50	168
BXCP-57C-11M-J19-3-A1-00-0-0	5700	70	500	2.80	3.00	3.30	252	1.50	168
BXCP-65C-11M-J19-3-A1-00-0-0	6500	70	500	2.80	3.00	3.30	252	1.50	168
BXCP-27E-11M-J19-3-A1-00-0-0	2700	80	500	2.80	3.00	3.30	204	1.50	136
BXCP-30E-11M-J19-3-A1-00-0-0	3000	80	500	2.80	3.00	3.30	215	1.50	143
BXCP-40E-11M-J19-3-A1-00-0-0	4000	80	500	2.80	3.00	3.30	234	1.50	156
BXCP-50E-11M-J19-3-A1-00-0-0	5000	80	500	2.80	3.00	3.30	234	1.50	156
BXCP-57E-11M-J19-3-A1-00-0-0	5700	80	500	2.80	3.00	3.30	234	1.50	156
BXCP-65E-11M-J19-3-A1-00-0-0	6500	80	500	2.80	3.00	3.30	234	1.50	156
BXCP-27G-11M-J19-3-A1-00-0-0	2700	90	500	2.80	3.00	3.30	173	1.50	115
BXCP-30G-11M-J19-3-A1-00-0-0	3000	90	500	2.80	3.00	3.30	182	1.50	121
BXCP-40G-11M-J19-3-A1-00-0-0	4000	90	500	2.80	3.00	3.30	195	1.50	130
BXCP-50G-11M-J19-3-A1-00-0-0	5000	90	500	2.80	3.00	3.30	195	1.50	130
BXCP-57G-11M-J19-3-A1-00-0-0	5700	90	500	2.80	3.00	3.30	195	1.50	130
BXCP-65G-11M-J19-3-A1-00-0-0	6500	90	500	2.80	3.00	3.30	195	1.50	130

- 1. The last 6 characters (including hyphens '-') refer to nominal flux, nominal forward voltage, and color bins, respectively. "00-o-o" denotes the full distribution of flux, forward voltage, and 5 SDCM color.
 - Example: BXCP-27G-11M-J19-3-A1-00-0-0 refers to the full distribution of flux, forward voltage, and color within a 2700K 5-step ANSI standard chromaticity region with a minimum of 90 CRI.
- 2. Product CCT is hot targeted at T_{so} = 85°C. Nominal CCT as defined by ANSI C78.377-2011.
- 3. Listed CRIs are minimum values and include test tolerance.
- 4. Products tested under pulsed condition (10ms pulse width) at nominal drive current where T_i=T_{so}=25°C.
- 5. Bridgelux maintains a ±7.5% tolerance on luminous flux measurements, ±0.1V tolerance on forward voltage measurements, and ±2 tolerance on CRI measurements for the CSP.
- 6. Refer to Table 6 and Table 7 for Bridgelux CSP Luminous Flux Binning and Forward Voltage Binning information.

Product Selection Guide

Table 2: Selection Guide, Pulsed Measurement Data at 500mA (T_i=T_{sn}=85°C)

				J SI	, -				
Part Number ^{1,5}	Nominal CCT ²	CRI3.4	Nominal Drive Current	Forward Voltage⁴ (V)		e ⁴	Typical Pulsed Flux4	Typical Power	Typical Efficacy
			(mA)	Min	Typical	Max	(lm)	(W)	(lm/W)
BXCP-30C-11M-J19-3-A1-00-0-0	3000	70	500	2.70	2.90	3.20	220	1.45	152
BXCP-40C-11M-J19-3-A1-00-0-0	4000	70	500	2.70	2.90	3.20	231	1.45	159
BXCP-50C-11M-J19-3-A1-00-0-0	5000	70	500	2.70	2.90	3.20	231	1.45	159
BXCP-57C-11M-J19-3-A1-00-0-0	5700	70	500	2.70	2.90	3.20	231	1.45	159
BXCP-65C-11M-J19-3-A1-00-0-0	6500	70	500	2.70	2.90	3.20	231	1.45	159
BXCP-27E-11M-J19-3-A1-00-0-0	2700	80	500	2.70	2.90	3.20	188	1.45	130
BXCP-30E-11M-J19-3-A1-00-0-0	3000	80	500	2.70	2.90	3.20	197	1.45	136
BXCP-40E-11M-J19-3-A1-00-0-0	4000	80	500	2.70	2.90	3.20	215	1.45	148
BXCP-50E-11M-J19-3-A1-00-0-0	5000	80	500	2.70	2.90	3.20	215	1.45	148
BXCP-57E-11M-J19-3-A1-00-0-0	5700	80	500	2.70	2.90	3.20	215	1.45	148
BXCP-65E-11M-J19-3-A1-00-0-0	6500	80	500	2.70	2.90	3.20	215	1.45	148
BXCP-27G-11M-J19-3-A1-00-0-0	2700	90	500	2.70	2.90	3.20	159	1.45	110
BXCP-30G-11M-J19-3-A1-00-0-0	3000	90	500	2.70	2.90	3.20	167	1.45	115
BXCP-40G-11M-J19-3-A1-00-0-0	4000	90	500	2.70	2.90	3.20	179	1.45	123
BXCP-50G-11M-J19-3-A1-00-0-0	5000	90	500	2.70	2.90	3.20	179	1.45	123
BXCP-57G-11M-J19-3-A1-00-0-0	5700	90	500	2.70	2.90	3.20	179	1.45	123
BXCP-65G-11M-J19-3-A1-00-0-0	6500	90	500	2.70	2.90	3.20	179	1.45	123

- 1. The last 6 characters (including hyphens '-') refer to nominal flux, nominal forward voltage, and color bins, respectively. "00-0-0" denotes the full distribution of flux, forward voltage, and 5 SDCM color.
- Example: BXCP-27G-11M-J19-3-A1-00-0-0 refers to the full distribution of flux, forward voltage, and color within a 2700K 5-step ANSI standard chromaticity region with a minimum of 90 CRI.
- 2. Product CCT is hot targeted at $T_{\rm sp}$ = 85°C. Nominal CCT as defined by ANSI C78.377-2011.
- 3. Listed CRIs are minimum values and include test tolerance.
- 4. Bridgelux maintains a ±7,5% tolerance on luminous flux measurements, ±0.1V tolerance on forward voltage measurements, and ±2 tolerance on CRI measurements for the CSP.
- 5. Refer to Table 6 and Table 7 for Bridgelux CSP Luminous Flux Binning and Forward Voltage Binning information.
- 6. Products tested under pulsed condition (10ms pulse width) at nominal drive current where Tj-Tsp-85°C.

CSP 1919 LEDs specifications at nominal drive current are shown in Table 1 and Table 2. CSP 1919 may also be driven at other drive currents dependent on specific application design requirements. The performance at any drive current can be derived from the current vs. voltage characteristics shown in Figure 2 and the relative luminous flux vs. current characteristics shown in Figure 3. The performance at commonly used drive currents is summarized in Table 3.

Table 3: Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Pulsed Flux² T _{sp} = 25°C (lm)	Typical Pulsed Flux³ T _{sp} = 85°C (lm)	Typical Efficacy T _{sp} = 25°C (lm/W)
		50	2.6	0.1	28	26	214
		250	2.8	0.7	131	120	185
		350	2.9	1.0	176	162	173
BXCP-30C-11M-J19-3-A1-00-0-0	70	500	3.0	1.5	240	220	160
		700	3.1	2.2	317	291	146
		900	3.2	2.9	384	352	132
		1200	3.4	4.1	479	440	118
		50	2.6	0.1	30	27	224
	ĺ	250	2.8	0.7	137	126	194
		350	2.9	1.0	185	170	182
BXCP-40C-11M-J19-3-A1-00-0-0	70	500	3.0	1.5	252	231	168
		700	3.1	2.2	332	305	153
		900	3.2	2.9	403	370	139
		1200	3.4	4.1	503	461	124
		50	2.6	0.1	30	27	224
		250	2.8	0.7	137	126	194
		350	2.9	1.0	185	170	182
BXCP-50C-11M-J19-3-A1-00-0-0	70	500	3.0	1.5	252	231	168
		700	3.1	2.2	332	305	153
		900	3.2	2.9	403	370	139
		1200	3.4	4.1	503	461	124
		50	2.6	0.1	30	27	224
		250	2.8	0.7	137	126	194
		350	2.9	1.0	185	170	182
BXCP-57C-11M-J19-3-A1-00-0-0	70	500	3.0	1.5	252	231	168
		700	3.1	2.2	332	305	153
		900	3.2	2.9	403	370	139
		1200	3.4	4.1	503	461	124
		50	2.6	0.1	30	27	224
		250	2.8	0.7	137	126	194
		350	2.9	1.0	185	170	182
BXCP-65C-11M-J19-3-A1-00-0-0	70	500	3.0	1.5	252	231	168
		700	3.1	2.2	332	305	153
		900	3.2	2.9	403	370	139
		1200	3.4	4.1	503	461	124

- 1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.
- 2. Bridgelux maintains a ± 7.5% tolerance on flux measurements.
- 3. Typical pulsed performance values are provided as reference only and are not a guarantee of performance.

Table 3: Performance at Commonly Used Drive Currents (Continued)

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Pulsed Flux² T _{sp} = 25°C (lm)	Typical Pulsed Flux³ T _{sp} = 85°C (lm)	Typical Efficacy T _{sp} = 25 C (lm/W)
		50	2.6	0.1	24	22	182
		250	2.8	0.7	111	102	158
		350	2.9	1.0	150	138	148
BXCP-27E-11M-J19-3-A1-00-0-0	80	500	3.0	1.5	204	188	136
		700	3.1	2.2	270	248	124
		900	3.2	2.9	327	300	113
		1200	3.4	4.1	408	374	100
		50	2.6	0.1	25	23	191
	Ì	250	2.8	0.7	117	107	166
		350	2.9	1.0	158	145	156
BXCP-30E-11M-J19-3-A1-00-0-0	80	500	3.0	1.5	215	197	143
		700	3.1	2.2	284	260	130
	İ	900	3.2	2.9	344	315	118
	Ī	1200	3.4	4.1	429	393	106
		50	2.6	0.1	28	25	208
		250	2.8	0.7	127	117	181
		350	2.9	1.0	172	158	170
BXCP-40E-11M-J19-3-A1-00-0-0	80	500	3.0	1.5	234	215	156
		700	3.1	2.2	309	284	142
		900	3.2	2.9	374	344	129
		1200	3.4	4.1	467	429	115
		50	2.6	0.1	28	25	208
		250	2.8	0.7	127	117	181
		350	2.9	1.0	172	158	170
BXCP-50E-11M-J19-3-A1-00-0-0	80	500	3.0	1.5	234	215	156
		700	3.1	2.2	309	284	142
		900	3.2	2.9	374	344	129
		1200	3.4	4.1	467	429	115
		50	2.6	0.1	28	25	208
		250	2.8	0.7	127	117	181
		350	2.9	1.0	172	158	170
BXCP-57E-11M-J19-3-A1-00-0-0	80	500	3.0	1.5	234	215	156
		700	3.1	2.2	309	284	142
		900	3.2	2.9	374	344	129
		1200	3.4	4.1	467	429	115

- 1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.
- 2. Bridgelux maintains a \pm 7.5% tolerance on flux measurements.
- 3. Typical pulsed performance values are provided as reference only and are not a guarantee of performance.

Table 3: Performance at Commonly Used Drive Currents (Continued)

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Pulsed Flux² T _{sp} = 25°C (lm)	Typical Pulsed Flux³ T _{sp} = 85°C (lm)	Typical Efficacy T _{sp} = 25°C (lm/W)
		50	2.6	0.1	28	25	208
		250	2.8	0.7	127	117	181
		350	2.9	1.0	172	158	170
BXCP-65E-11M-J19-3-A1-00-0-0	80	500	3.0	1.5	234	215	156
		700	3.1	2.2	309	284	142
		900	3.2	2.9	374	344	129
		1200	3.4	4.1	467	429	115
		50	2.6	0.1	20	19	154
		250	2.8	0.7	94	87	134
		350	2.9	1.0	127	117	126
BXCP-27G-11M-J19-3-A1-00-0-0	90	500	3.0	1.5	173	159	115
		700	3.1	2.2	229	210	105
		900	3.2	2.9	277	255	96
		1200	3.4	4.1	346	317	85
		50	2.6	0.1	21	20	162
		250	2.8	0.7	99	91	141
		350	2.9	1.0	134	123	132
BXCP-30G-11M-J19-3-A1-00-0-0	90	500	3.0	1.5	182	167	121
		700	3.1	2.2	241	221	111
		900	3.2	2.9	291	268	100
		1200	3.4	4.1	364	334	90
		50	2.6	0.1	23	21	174
		250	2.8	0.7	106	98	151
		350	2.9	1.0	144	132	142
BXCP-40G-11M-J19-3-A1-00-0-0	90	500	3.0	1.5	195	179	130
		700	3.1	2.2	258	237	119
		900	3.2	2.9	313	287	108
		1200	3.4	4.1	390	358	96
		50	2.6	0.1	23	21	174
		250	2.8	0.7	106	98	151
	90	350	2.9	1.0	144	132	142
BXCP-50G-11M-J19-3-A1-00-0-0		500	3.0	1.5	195	179	130
		700	3.1	2.2	258	237	119
		900	3.2	2.9	313	287	108
		1200	3.4	4.1	390	358	96

- 1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.
- 2. Bridgelux maintains a ± 7.5% tolerance on flux measurements.
- 3. Typical pulsed performance values are provided as reference only and are not a guarantee of performance.

Table 3: Performance at Commonly Used Drive Currents (Continued)

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Pulsed Flux² T _{sp} = 25˚C (lm)	Typical Pulsed Flux³ T _{sp} = 85°C (lm)	Typical Efficacy T _{sp} = 25°C (lm/W)
		50	2.6	0.1	23	21	174
		250	2.8	0.7	106	98	151
		350	2.9	1.0	144	132	142
BXCP-57G-11M-J19-3-A1-00-0-0	90	500	3.0	1.5	195	179	130
		700	3.1	2.2	258	237	119
		900	3.2	2.9	313	287	108
		1200	3.4	4.1	390	358	96
		50	2.6	0.1	23	21	174
		250	2.8	0.7	106	98	151
		350	2.9	1.0	144	132	142
BXCP-65G-11M-J19-3-A1-00-0-0	90	500	3.0	1.5	195	179	130
		700	3.1	2.2	258	237	119
		900	3.2	2.9	313	287	108
		1200	3.4	4.1	390	358	96

- 1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.
- 2. Bridgelux maintains a \pm 7.5% tolerance on flux measurements.
- 3. Typical pulsed performance values are provided as reference only and are not a guarantee of performance.

Electrical and Thermal Characteristics

Table 4: Electrical and Thermal Characteristics

	Drive Current	Forward Voltage ^{2,3} (V)			Typical Temperature Coefficient	Typical Thermal Resistance	
Part Number ¹	(mA)	Minimum	Typical	Maximum	of Forward Voltage⁴ ∆V,∕∆T (mV/°C)	Junction to Solder Point ^{5,6} R _{j-sp} (°C/W)	
BXCP-xxx-11M-J19-3-A1-00-0-0	350	2.60	2.80	3.20	-1.5	3.5	

- 1. The last 6 characters (including hyphens '-') refer to nominal flux, nominal forward voltage, and color bins, respectively. "00-0-0" denotes the full distribution of flux, forward voltage, and 5 SDCM color.
- Example: BXCP-27G-11M-J1g-3-A1-00-0-0 refers to the full distribution of flux, forward voltage, and color within a 2700K 5-step ANSI standard chromaticity region with a minimum of 90 CRI.
- 2. Products tested under pulsed condition (10ms pulse width) where T_{sp} = 85 $^{\circ}$ C.
- 3. Bridgelux maintains a tolerance of ± 0.1V on forward voltage measurements.
- 4. Products measured between 25°C and 105°C under pulsed condition (10ms pulse width).
- 5. Thermal Resistance values based on 2700K 90 CRI product.
- 6. Thermal resistance value was calculated using total electrical input power, optical power was not subtracted from input power.

Absolute Maximum Ratings

Table 5: Maximum Ratings

Parameter	Maximum Rating			
LED Junction Temperature (T _j)	135°C			
Storage Temperature	-40°C to +125°C			
Operating Solder Point Temperature (T _{Sp})	-40°C to +105°C			
Soldering Temperature	260°C or lower for a maximum of 10 seconds			
Maximum Drive Current ¹	1200mA			
Maximum Peak Pulsed Forward Current ²	1500mA			
Maximum Reverse Voltage ³	-5V			
Moisture Sensitivity Rating	MSL 3			
Electrostatic Discharge	2kV HBM. JEDEC-JS-001-HBM and JEDEC-JS-001-2012			

- ${\tt 1.} \ \ {\tt The\ maximum\ drive\ current\ is\ limited\ depending\ on\ the\ solder\ point\ temperature.\ Refer\ to\ Figure\ 7.}$
- 2. Bridgelux recommends a maximum duty cycle of 10% and pulse width of 10 ms when operating CSP LED at maximum peak pulsed current specified. Maximum peak pulsed currents indicate values where CSP LED can be driven without catastrophic failures.
- 3. Light emitting diodes are not designed to be driven in reverse voltage and will not produce light under this condition. Maximum rating provided for reference only.

Product Bin Definitions

Table 6 lists the standard photometric luminous flux bins for Bridgelux CSP 1919 LEDs. Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all CCTs.

Table 6: Luminous Flux Bin Definitions at 350mA, T_{sp} =85 $^{\circ}$ C

Bin Code	Minimum	Maximum	Unit	Condition
l1	110	120		
J1	120	130		
K1	130	140		L 050m A
M1	140	150		
N1	150	160	- lm	I _F =350mA
P1	160	170		
Q1	170	180		
R1	180	190		

Note for Table 6:

1. Bridgelux maintains a tolerance of \pm 7.5% on luminous flux measurements.

Table 7: Forward Voltage Bin Definition at 350mA, T_{sp} =85°C

Bin Code	Minimum	Maximum	Unit	Condition
С	2.6	2.8		
D	2.8	3.0		1 250m A
E	3.0	3.2	v	I _F =350mA
F	3.2	3.4		

Note for Table 7:

1. Bridgelux maintains a tolerance of ± 0.1V on forward voltage measurements.

Product Bin Definitions

Table 8: 3- and 5-step MacAdam Ellipse Color Bin Definitions (T_{sp} =85°C)

	Table 8: 3- and 5-step MacAdam Ellipse Color Bin Defnitions (Tsp=85°C)								
ССТ	Color Space	Cente	er Point	Major Axis	minor Axis	θ'(angle)	Color Bin (2,3)		
CC1	Color Space	x	У	Iviajoi Axis	IIIIIOI AXIS	o (angle)			
	2			0.0054	0.0028		2		
2700K	3	0.4578	0.4101	0.0081	0.0042	53.70	3		
	5			0.0135	0.0070		5(E/F/G/H)		
	2			0.0056	0.0027		2		
3000K	3	0.4338	0.4030	0.0083	0.0041	53.22	3		
	5			0.0139	0.0068		5(E/F/G/H)		
	2			0.0062	0.0028		2		
3500K	3	0.4073	0.3917	0.0093	0.0041	54.00	3		
	5			0.0155	0.0069		5(E/F/G/H)		
	2			0.0063	0.0027		2		
4000K	3	0.3818	0.3797	0.0094	0.0040	53.72	3		
	5			0.0157	0.0067		5(E/F/G/H)		
	2			0.0055	0.0024		2		
5000K	3	0.3447	0.3553	0.0082	0.0035	59.62	3		
	5			0.0137	0.0059		5(E/F/G/H)		
	2			0.0050	0.0021		2		
5700K	3	0.3287	0.3417	0.0075	0.0032	59.09	3		
	5]		0.0124	0.0053		5(E/F/G/H)		
	2			0.0045	0.0019		2		
6500K	3	0.3123	0.3282	0.0067	0.0029	58.57	3		
	5			0.0112	0.0048		5(E/F/G/H)		

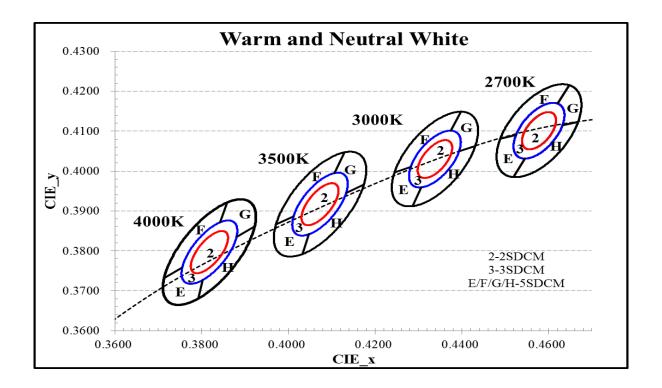
^{1.}Bridgelux maintains a tolerance of ± 0.007 on x and y color coordinates in the CIE 1931 color space.

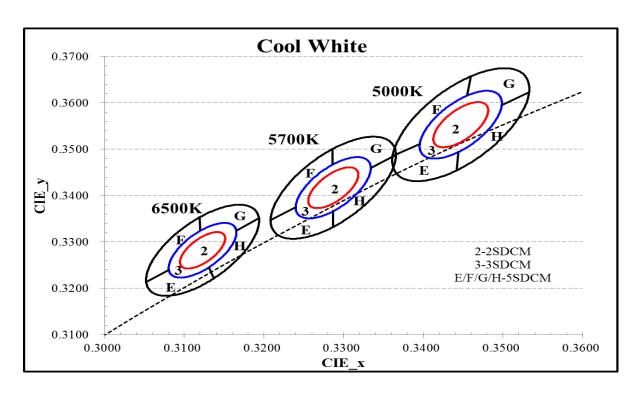
^{2.} MacAdam Ellipse Color bin code for CRI ≥ 90: 2(2 SDCM)/ 3(3 SDCM)/ EFGH(5 SDCM).

^{3.} MacAdam Ellipse Color bin code for CRI < 90: 3(3 SDCM)/ 5(5 SDCM).

Product Bin Definitions

Figure 1: C.I.E. 1931 Chromaticity Diagram (Color Bin Structure, T_{sp}=85°C)





Performance Curves

Figure 2: Drive Current vs. Voltage (T_{sp}=85°C)

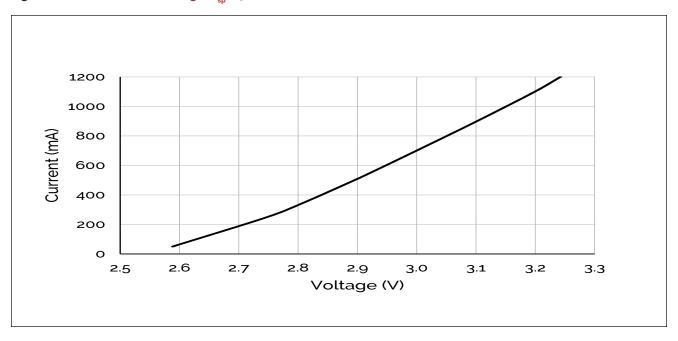
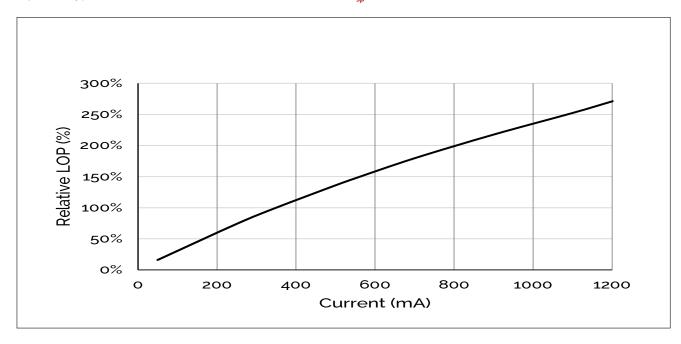


Figure 3: Typical Relative Luminous Flux vs. Drive Current (T_{sp}=85°C)



Note for Figure 3:

^{1.} Bridgelux does not recommend driving this CSP LED at low current (< 10mA). Doing so may produce unpredictable results. Pulse width modulation (PWM) is recommended for dimming effects.

Performance Curves

Figure 4: Typical Relative Flux vs. Solder Point Temperature_350mA

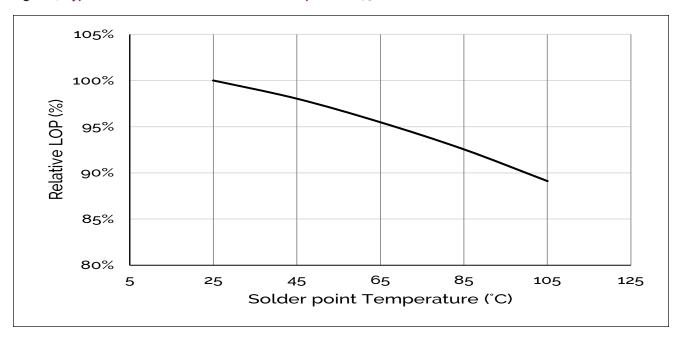
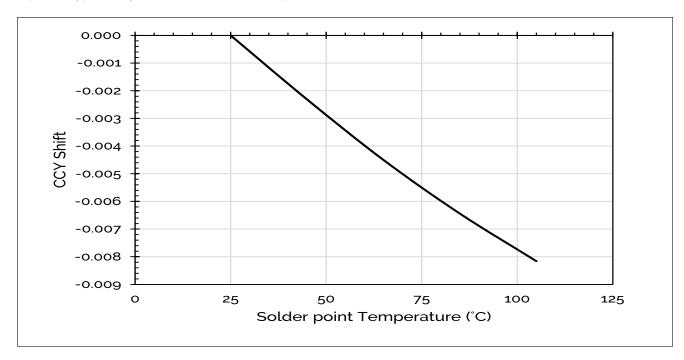


Figure 5: Typical ccy Shift vs. Solder Point Temperature_350mA



Notes for Figures 4 & 5:

^{1.} Characteristics shown for warm white based on 2700K and 90 CRI.

^{2 .} For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

Performance Curves

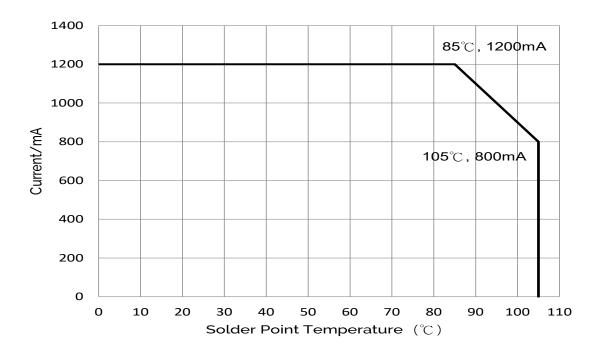
0.000
-0.001
-0.001
-0.002
-0.002
-0.003
-0.003
-0.004
0 25 50 75 100 125
Solder point Temperature (°C)

Figure 6: Typical ccx Shift vs. Solder Point Temperature_350mA

Notes for Figure 6:

- 1. Characteristics shown for warm white based on 2700K and 90 CRI.
- 2. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

Figure 7: Drive Current vs Solder Point Temperature



Typical Radiation Pattern

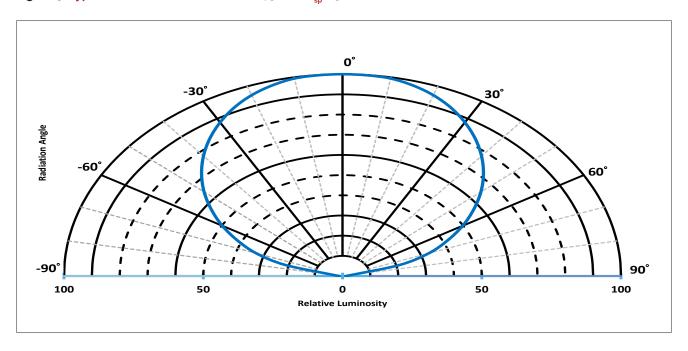
100% 80% Relative Intensity 60% 40% 20% 0% -75 -60 -45 45 60 75 -90 90 **Angular Displacement (°)**

Figure 8: Typical Spatial Radiation Pattern at 350mA, T_{sp}=25°C

Notes for Figure 8:

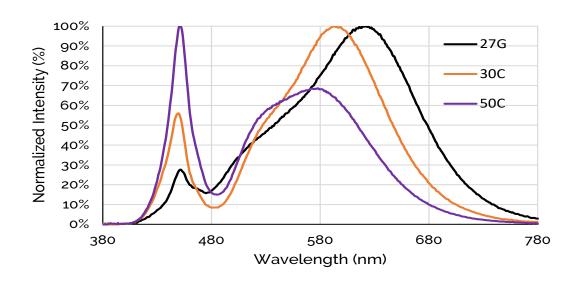
- 1. Typical viewing angle is 120°.
- 2. The viewing angle is defined as the off axis angle from the centerline where lv is $\frac{1}{2}$ of the peak value.

Figure 9: Typical Polar Radiation Pattern at 350mA, T_{sp} =25°C



Typical Color Spectrum

Figure 10: Typical Color Spectrum at 350mA, Tsp=85°C

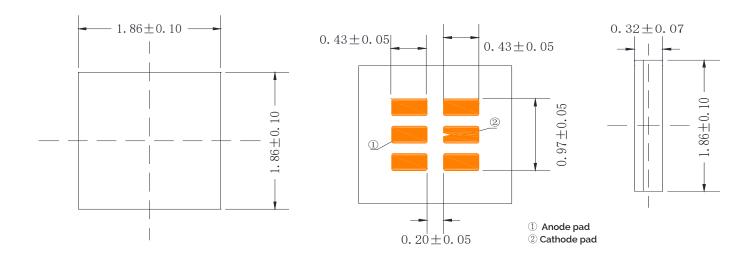


Notes for Figure 10:

- 1. Color spectra shown for warm white is 2700K and 90 CRI.
- 2. Color spectra shown for warm white is 3000K and 70 CRI.
- 3. Color spectra shown for cool white is 5000K and 70 CRI.

Mechanical Dimensions

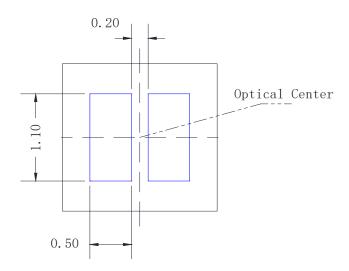
Figure 11: Drawing for CSP 1919



Notes for Figure 11:

- 1. Drawings are not to scale.
- 2. Drawing dimensions are in millimeters.
- 3. Unless otherwise specified, tolerances are ± 0.10mm.
- 4. The optical center of the LED emitter is nominally defined by the mechanical center of the emitter. The light emitting surface (LES) is centered on the mechanical center of the LED emitter to a tolerance of ± 0.2 mm

Recommended PCB Soldering Pad Pattern



Reliability

Table 9: Reliability Test Items and Conditions

No.	ltems	Reference Standard	Test Conditions	Drive Current	Test Duration	Units Failed/Tested
1	Moisture Sensitivity Level	J-STD-020E	T _{sld} = 260°C, 10sec, Precondition: 85°C, 60%RH, 168hr		3 reflows	0/22
2	Low Temperature Storage	JESD22-A119	T _a =-40°C		1000 hours	0/22
3	High Temperature Storage	JESD22-A103D	T _a =125°C		1000 hours	0/22
4	Low Temperature Operating Life	JESD22-A108D	T _a =-40°C	1200mA	1000 hours	0/22
5	Temperature Humidity Operating Life	JESD22-A101C	T _{sp} =85°C, RH=85%	1200mA	1000 hours	0/22
6	High Temperature Operating Life	JESD22-A108D	T _{sp} =85°C	1200mA	1000 hours	0/22
7	Thermal Shock	JESD22-A106B	T _a =-40°C ~125°C; Dwell : 15min; Transfer: 10sec		200 Cycle	0/22
8	Temperature Cycle	JESD22-A104E	T _a =-40°C ~125°C; Dwell at extreme temperature: 15min; Ramp rate < 105°C/min		200 Cycle	0/22
9	Electrostatic Discharge	Electrostatic Discharge JS-001-2012 HBM, 2KV, 1.5kΩ, 10 Alternately positive or r				0/22
10	Vibration Test	JESD22-B103	10m/s² , 100~20000~100Hz 4 cycles,4min,eachX,Y,Z		4 Cycles	0/22

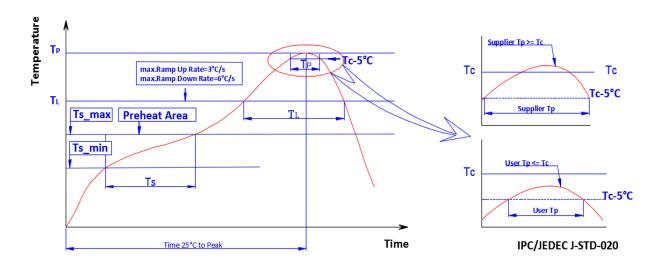
Passing Criteria

ltem	Symbol	Test Condition	Passing Criteria	
Forward Voltage	Vf	1200mA	ΔVf<10%	
Luminous Flux	lv	1200mA	Δlv<30%	
Chromaticity Coordinates	(x, y)	1200mA	Δu'v'<0.007	

- 1. Test board: Aluminum board thickness =1.0mm, Copper layer thickness=70um.
- 2. Measurements are performed after allowing the LEDs to return to room temperature $\,$
- 3. $T_{\rm sld}$: reflow soldering temperature; $T_{\rm a}$: ambient temperature

Reflowing Characteristics

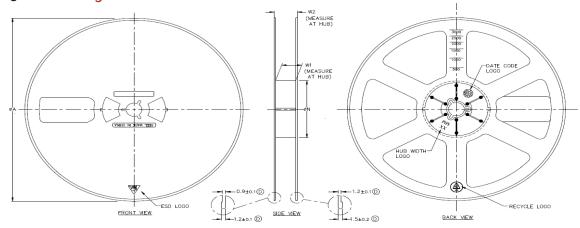
Figure 12: Reflow Profile

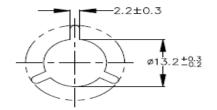


Profile Parameters	Lead-Free Solder SAC305
Average Ramp-Up Rate (T₅ _{max} to T♭)	3°C/second max.
Preheat: Temperature Min (T _{s min})	150°C
Preheat: Temperature Max (T _{s max})	190°C
Preheat: Time (t _{s min} to t _{s max})	90-120 seconds
Liquidous Temperature (T ₋)	217°C
Time Maintained Above Liquidous Temperature (T _L): Time (t ₋)	60-90 seconds
Peak/Classification Temperature (T _P)	250-255°C
Time Within 10°C of Actual Peak Temperature (T _P)	20-40 seconds
Ramp-Down Rate	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

Packaging

Figure 13: Reel Drawings



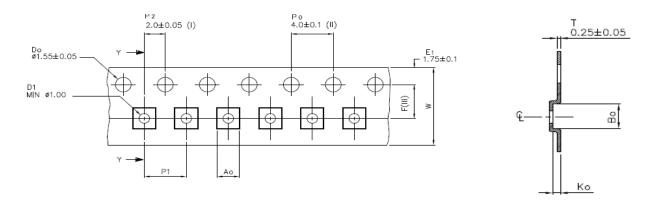


PRODUCT SPECIFICATIONS					
TAPE WIDTH	ØA ±1.0	øN ±0.5	W1 ±0.5	W2 (MAX)	
MM80	ø178.0	54.0	9.5	15.0	

Note for Figure 13:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Figure 14: Tape Drawings



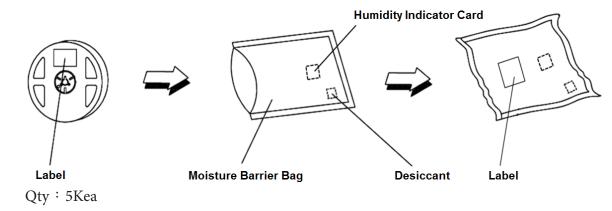
Ao	Во	Ко	F	P1	W
2.20±0.05	2.2±0.05	0.55±0.05	3.5±0.05	4.00±0.10	8.00 + 0.3 - 0.1

Note for Figure 14:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Packaging

Figure 15: Reel Packaging Drawings



Note for Figure 15:

1. Drawings are not to scale.

Design Resources

Optical Source Models

Please contact your Bridgelux sales representative for assistance.

Precautions

CAUTION: CHEMICAL EXPOSURE HAZARD

Exposure to some chemicals commonly used in luminaire manufacturing and assembly can cause damage to the CSP.

CAUTION: EYE SAFETY

Eye safety classification for the use of Bridgelux CSP is in accordance with IEC specification 62471: Photobiological Safety of Lamps and Lamp Systems.

Most of Bridgelux CSPs are classified as Risk Group Exempt or Risk Group 1 in accordance with IEC specification 62471. However, the CSP LEDs will be classified as Risk Group 2 when operated at high power conditions with high ratio blue wavelength in the emission spectrum depending on characteristics. Please use appropriate precautions. It is important that employees working with LEDs are trained to use them safely.

CAUTION: RISK OF BURN

Do not touch the CSP LES during operation. Allow the CSP to cool for a sufficient period of time before handling. The CSP may reach elevated temperatures such that could burn skin when touched.

Disclaimers

MINOR PRODUCT CHANGE POLICY

The rigorous qualification testing on products offered by Bridgelux provides performance assurance. Slight cosmetic changes that do not affect form, fit, or function may occur as Bridgelux continues product optimization.

CAUTION: PICK AND PLACE

Recommend using Teflon material for nozzle. Sharp steel material must not be used as pick up tools.

CAUTION



STANDARD TEST CONDITIONS

Unless otherwise stated, LED emitter testing is performed at the nominal drive current.

About Bridgelux: Bridging Light and Life™

At Bridgelux, we help companies, industries and people experience the power and possibility of light. Since 2002, we've designed LED solutions that are high performing, energy efficient, cost effective and easy to integrate. Our focus is on light's impact on human behavior, delivering products that create better environments, experiences and returns—both experiential and financial. And our patented technology drives new platforms for commercial and industrial luminaires.

For more information about the company, please visit bridgelux.com twitter.com/Bridgelux facebook.com/Bridgelux WeChat ID: BridgeluxInChina



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